## Reexamination 09/851,313 USAMI, TATSUYA Notice of References Cited Examiner Art Unit

Application/Control No.

Page 1 of 1 Julio J. Maldonado 2823

Applicant(s)/Patent Under

## **U.S. PATENT DOCUMENTS**

| * |     | Document Number<br>Country Code-Number-Kind Code | Date<br>MM-YYYY | Name          | Classification |
|---|-----|--|-----------------|---------------|----------------|
| * | Α   | US-6,054,379                                     | 04-2000         | Yau et al.    | 438/623        |
| * | В   | US-6,333,257                                     | 12-2001         | Aoi, Nobuo    | 438/626        |
| * | С   | US-6,218,317                                     | 04-2001         | Allada et al. | 438/780        |
| * | ۵   | US-  |                 |               | *              |
|   | ш   | US-  |                 |               |                |
|   | F   | US-  |                 |               |                |
|   | G   | US-  |                 |               |                |
|   | Н   | US-  |                 |               |                |
|   | l   | US-  |                 | ·             | ·              |
|   | J   | US-  |                 | ·             |                |
|   | К   | US-  |                 |               |                |
|   | الد | US-  |                 |               |                |
|   | М   | US-  |                 |               |                |

## **FOREIGN PATENT DOCUMENTS**

| * |   | Document Number<br>Country Code-Number-Kind Code | Date<br>MM-YYYY | Country   | Name | Classification |
|---|---|--|-----------------|-----------|------|----------------|
|   | N |  |                 |           |      |                |
|   | 0 |  |                 |           |      |                |
|   | Р |  | ,,,,,           |           |      |                |
|   | Q |  |                 |           |      |                |
|   | R |  |                 | . <u></u> |      |                |
|   | S |  |                 |           |      |                |
|   | Т |  |                 |           |      |                |

## **NON-PATENT DOCUMENTS**

| * |   | Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages)  |
|---|---|--|
| * | U | Wolf et al., Silicon Processing for the VLSI Era, Volume 1, PRocess teachnology, 1986 by Lattice Press, pages 168-174  |
| * | ٧ | Chen et al., Effects of Slurry formulations on chemical-mechanical polishing of low dielectric constant polysiloxanes: hydrido-<br>organo siloxane and methyl silsesquioxane; J. Vac. Sci. Technol. B 18(1), Jan/Feb 2000, pages 201-207 |
|   | W |  |
|   | х |  |

\*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)

Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.